MC 1,5/11-GF-3,81 P20 THRR72 - PCB header

1782116

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PCB headers, nominal cross section: 1.5 mm^2, color: black, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Sn, contact connection type: Pin, number of rows: 1, number of positions: 11, product range: MC 1,5/..-GF-THR, pitch: 3.81 mm, mounting: THR soldering / wave soldering, pin layout: Linear pinning, solder pin [P]: 2 mm, number of solder pins per potential: 1, plug-in system: COMBICON MC 1,5, Pin connector pattern alignment: Standard, locking: Screw locking mechanism, mounting method: Threaded flange, type of packaging: 72 mm wide tape

Your advantages

- Designed for integration into the SMT soldering process
- Screwable flange for superior mechanical stability
- Maximum flexibility when it comes to device design – one header for connectors with different connection technologies

Commercial data

Item number	1782116
Packing unit	380 pc
Minimum order quantity	380 pc
Sales key	AA02
Product key	AABTBA
GTIN	4046356550697
Weight per piece (including packing)	2.48 g
Weight per piece (excluding packing)	2.2 g
Customs tariff number	85366930
Country of origin	DE

Technical data

Product properties

Product type	PCB headers
Product family	MC 1,5/..-GF-THR
Product line	COMBICON Connectors S
Type	Component suitable for through hole reflow
Number of positions	11
Pitch	3.81 mm
Number of rows	1
Mounting type	Threaded flange
Pin layout	Linear pinning
Solder pins per potential	1

Fitting of components

Partial assembly	No

Electrical properties

Properties

Nominal current I_N	8 A
Nominal voltage U_N	160 V
Contact resistance	1.4 mΩ
Rated voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	250 V
Rated surge voltage (II/2)	2.5 kV

Mounting

Mounting type	THR soldering / wave soldering
Pin layout	Linear pinning

Flange

Tightening torque	0.3 Nm

Processing notes

Process	Reflow/wave soldering
Moisture Sensitive Level	MSL 1
Classification temperature T_c	260 °C
Solder cycles in the reflow	3

Material specifications

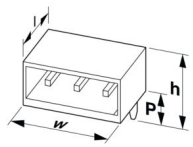
Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 µm - 5 µm Sn)
Metal surface contact area (middle layer)	Nickel (1.3 µm - 3 µm Ni)
Metal surface soldering area (top layer)	Tin (3 µm - 5 µm Sn)
Metal surface soldering area (middle layer)	Nickel (1.3 µm - 3 µm Ni)

Material data - housing

Color (Housing)	black (9005)
Insulating material	LCP
Insulating material group	IIIa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Dimensions

Dimensional drawing	
Pitch	3.81 mm
Width [w]	52.3 mm
Height [h]	8.9 mm
Length [l]	9.2 mm
Installed height	6.9 mm
Solder pin length [P]	2 mm
Pin dimensions	0.8 x 0.8 mm

PCB design

Hole diameter	1.4 mm

Mechanical tests

Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

Polarization and coding

Specification	IEC 60512-13-5:2006-02
Result	Test passed

Contact holder in insert

Specification	IEC 60512-15-1:2008-05
Contact holder in insert Requirements >20 N	Test passed

Insertion and withdrawal forces

Specification	IEC 60512-13-2:2006-02
Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	8 N
Withdraw strength per pos. approx.	6 N

Electrical tests

Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	20

Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	IIIa
Comparative tracking index (IEC 60112)	CTI 175
Rated insulation voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	2.5 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.6 mm
Rated insulation voltage (II/2)	250 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	2.5 mm

Environmental and real-life conditions

Durability test

Specification	IEC 60512-9-1:2010-03

Impulse withstand voltage at sea level	2.95 kV
Contact resistance R_1	1.4 mΩ
Contact resistance R_2	1.5 mΩ
Insertion/withdrawal cycles	25

Climatic test

Specification	ISO 6988:1985-02
Corrosive stress	0.2 dm^3 SO_2 on 300 dm^3/40 °C/1 cycle
Thermal stress	100 °C/168 h
Power-frequency withstand voltage	1.39 kV

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

Shocks

Specification	IEC 60068-2-27:2008-02
Pulse shape	Half-sine
Acceleration	30g
Shock duration	18 ms
Test directions	X-, Y- and Z-axis (pos. and neg.)

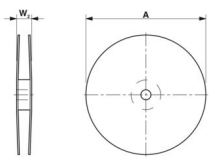
Railway application: Shocks

Acceleration	30g
Shock duration	18 ms
Test directions	X-, Y- and Z-axis (pos. and neg.)

Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

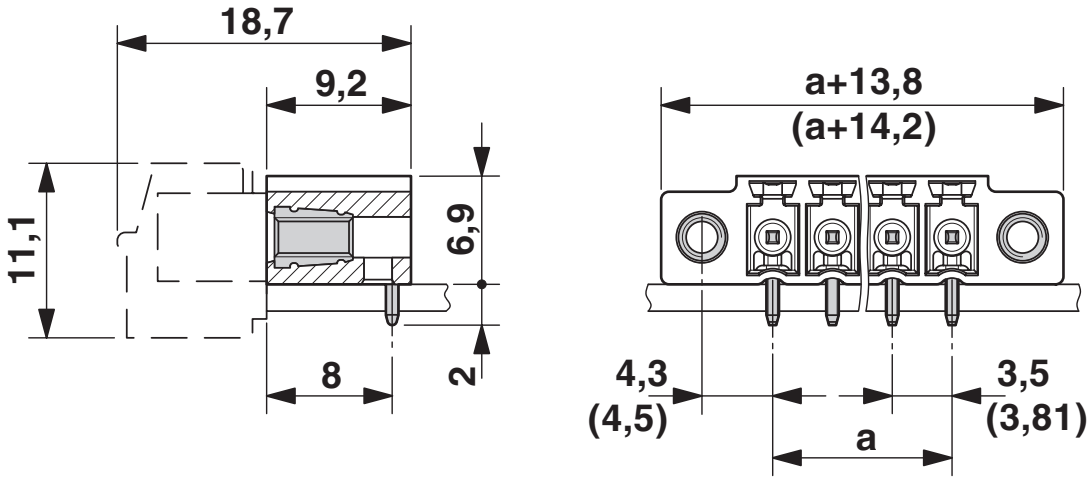
Packaging specifications

Dimensional drawing	
Type of packaging	72 mm wide tape
[W] tape width	72 mm

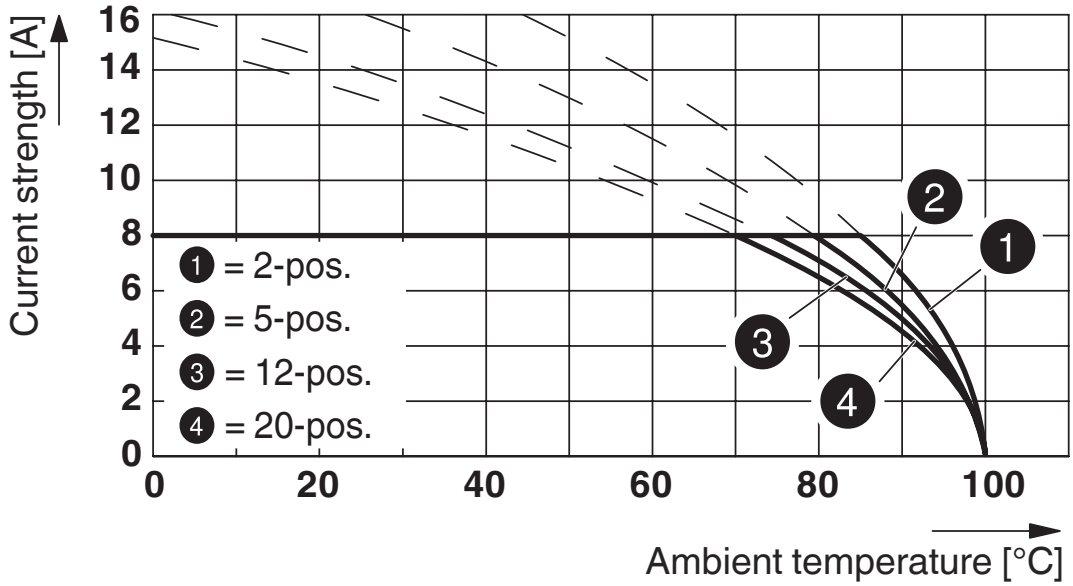
[W2] coil overall dimension	≤ 78.4 mm
[A] coil diameter	≤ 330 mm
Outer packaging type	Transparent-Bag

Drawings

Dimensional drawing

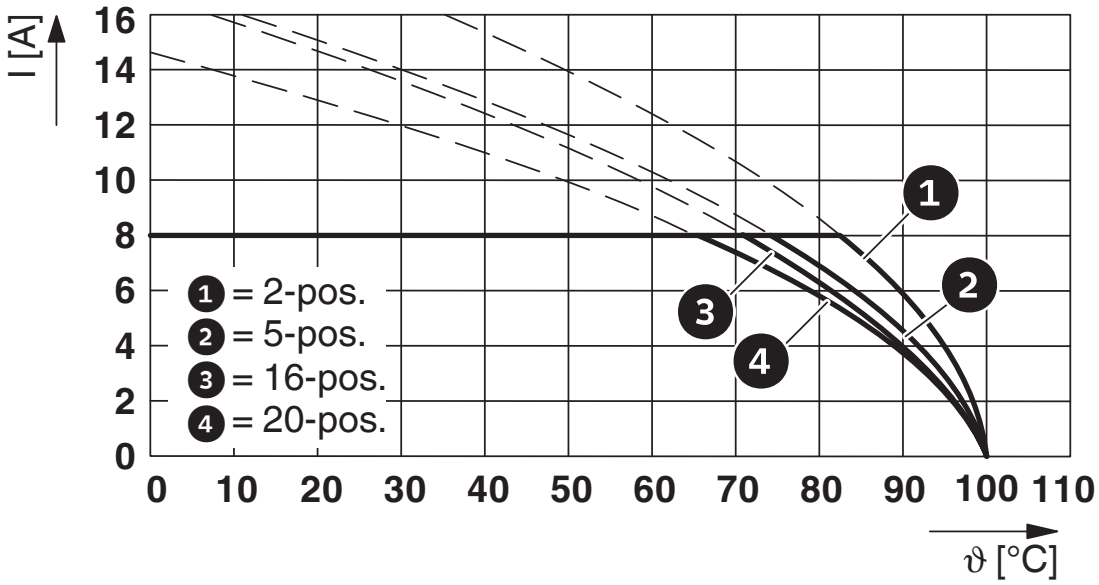


Diagram



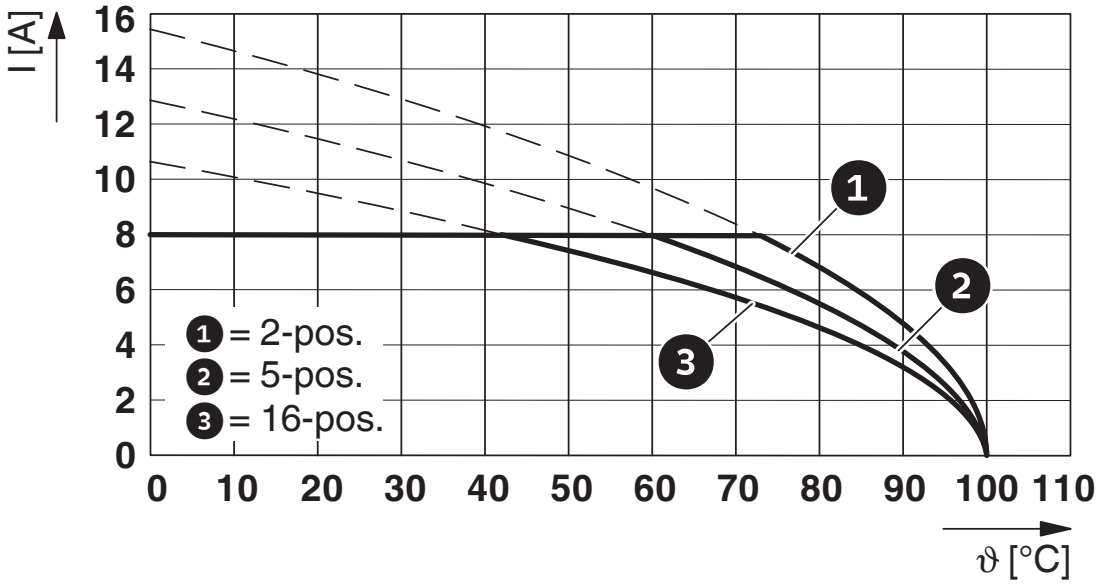
Type: FK-MCP 1,5/...-STF-3,81 with MC 1,5/...-GF-3,81 P... THR

Diagram



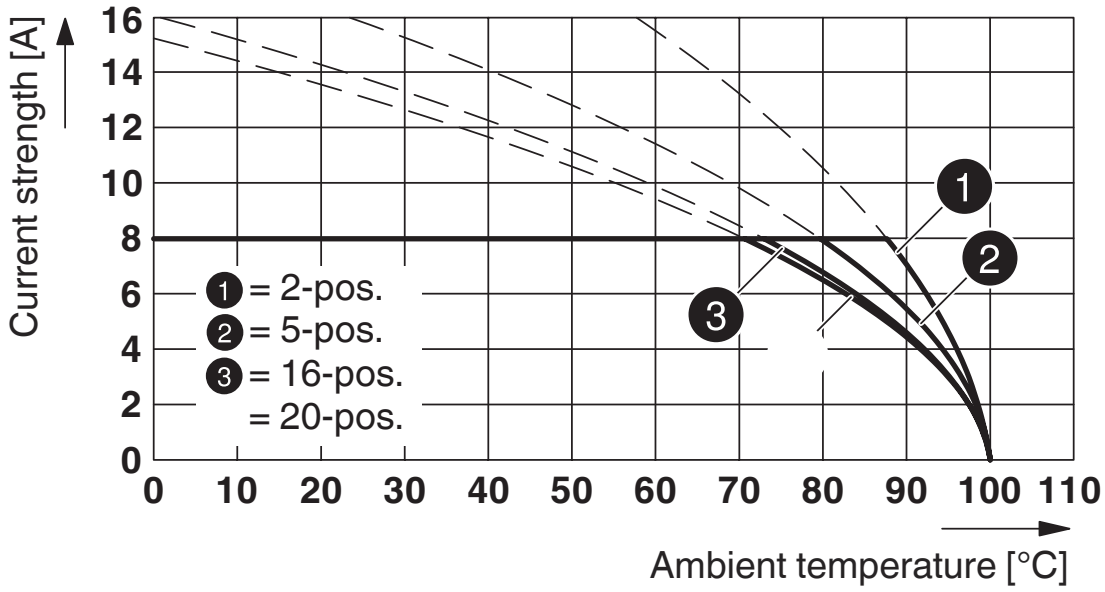
Type: FMC 1,5/...-STF-3,81 with MC 1,5/...-GF-3,81 P...THR

Diagram



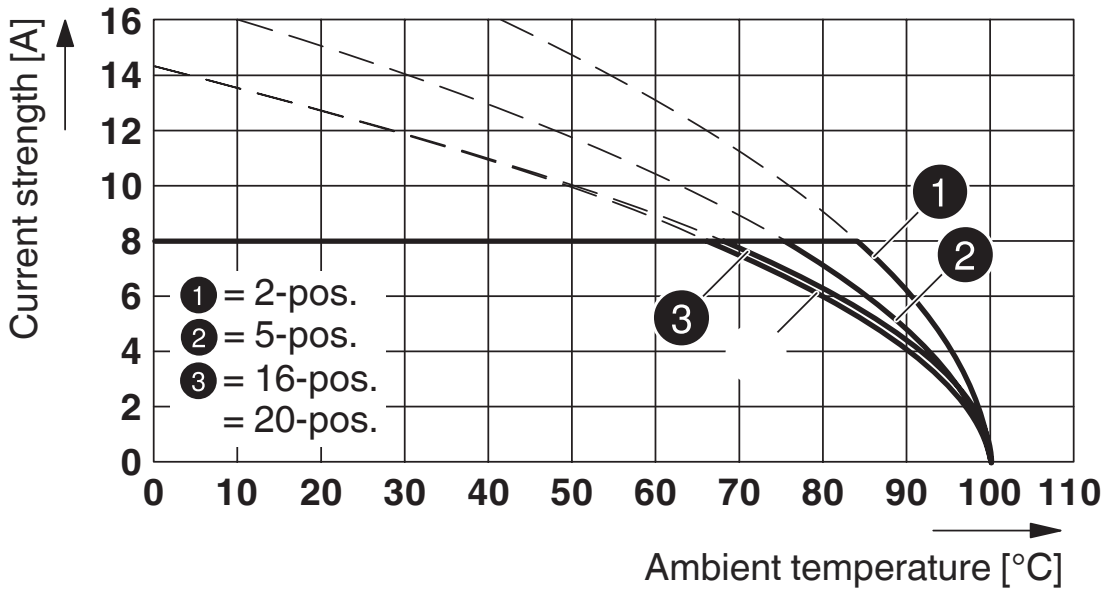
Type: MCV(W/R) 1,5/...-STF-3,81 with MC 1,5/...-GF-3,81 P...THR

Diagram



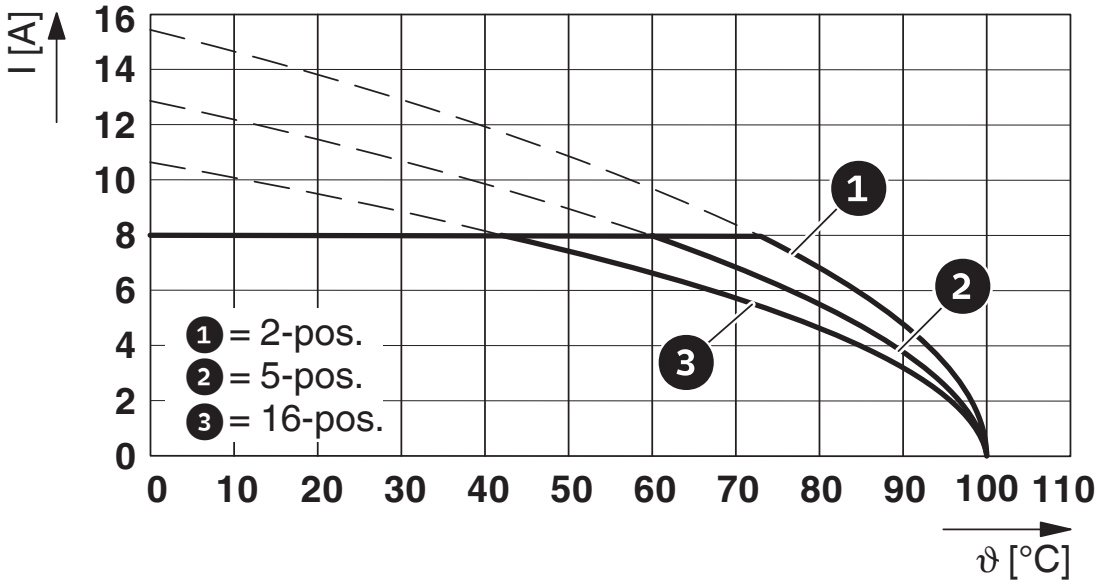
Type: MC 1,5/...-STF-3,81 with MC 1,5/...-GF-3,81 P26THR

Diagram



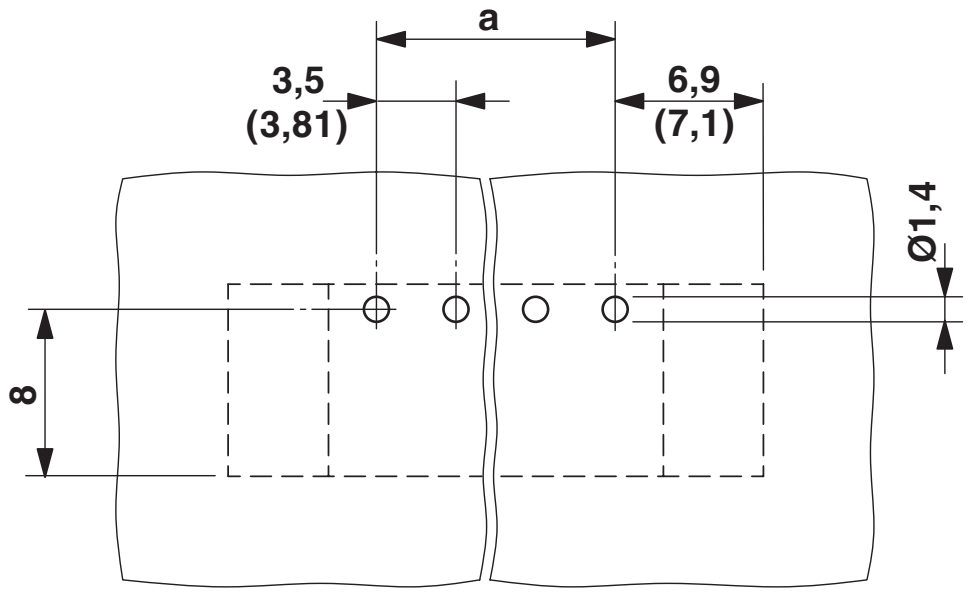
Type: FRONT-MC 1,5/...-STF-3,81 with MC 1,5/...-GF-3,81 P...THR

Diagram



Type: MCV(W/R) 1,5/...-STF-3,81 with MC 1,5/...-GF-3,81 P...THR

Drilling plan/solder pad geometry



Classifications

ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

ETIM

ETIM 10.0	EC002637

UNSPSC

UNSPSC 21.0	39121400

Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions

China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%

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https://www.phoenixcontact.com

Phoenix Contact USA
586 Fulling Mill Road
Middletown, PA 17057, United States
(+717) 944-1300
info@phoenixcon.com